

Change in layer thickness at the LMZF(L)

Dear Madam or Sir,

Product adaptations are used for continuous product and/or process improvement. The listed articles are supplied in a modified printing process. Please pass this product information on to your employees and, if necessary, to your customers.

1. General Overview

Type of notification: PCN PDN Short-term action

Short-term action due to:

<input type="checkbox"/> Software / Firmware Bugfix	<input type="checkbox"/> Short term delivery stop by supplier
<input type="checkbox"/> Short term recall by supplier	<input type="checkbox"/> Force majeure
<input type="checkbox"/> Product improvement with customer benefit	<input checked="" type="checkbox"/> other

2. Technical changes

In order to achieve the general product improvement, we would like to inform you with this letter that with immediate effect the solder pins of the LMZF(L) have a layer thickness of 4-10 µm Sn instead of 5-8 µm Sn.

3. Availability

This letter is to inform you that the change will be implemented in production from September 2024. There will be no stock adjustment. Therefore, there may be mixes of variants within a delivery from this date, but not in one packaging unit.

4. Affected parts

A complete list of all affected articles can be found in the attachment.

5. Data

All technical data and functional features are unaffected by this measure.

Detailed information on the technical data can be found for the individual products in the online catalog.

We are very sorry for all the inconveniences caused and doing everything to adjust this product change as smooth as possible without big influence on delivery times and general functions.

For further questions please contact your sales office directly. All contacts for sales representatives are available here:

<http://www.weidmueller.com/contact>

Best regards

Product Management

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